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		· 102	2462520		riginal document or copy thereof
1.	Names of conveying par			2. Name and address	of receiving party:
	1) MASAKI AOSHIMA 2) HIROYASU INOUE	5 07	~ 7	Name: TDK CORPO	
	3) KOJI MISHIMA	0.23	>- 00		
i	4) HIDEKI HIRATA			Internal Address:	
	5) HAJIME UTSUNOMI	YA			160
	6)				ň
Ad	dditional names of conveying participation	rties attached?	Yes <u>X</u> No		
3.	Nature of conveyance:			Street Address: 1-1	3-1, NIHONBASHI
	X_Assignment Merger				
	Security Agreemer	nt Change	of Name	<u></u>	KYO
	Other		Postal Code & City:	103-8272, CHUO-KU	
	Execution Dates: 1) MAY 20, 2003	4) MAY 20, 2003	L.	Country JAPAN	
	1) <u>MAY 20, 2003</u> 2) <u>MAY 20, 2003</u> 3) <u>MAY 20, 2003</u>	5) <u>MAY 20, 2003</u> 6)		Additional names & addresse	es attached? _Yes <u>X</u> No
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4.		the filing o	t is being filed to date of the appl	ogether with a new applic lication is <u>MAY 23, 2003</u> .	cation,
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PATENT REEL: 014113 FRAME: 0356

ASSIGNMENT

WHEREAS, we, Masaki AOSHIMA, Hiroyasu INOUE, Koji MISHIMA, Hideki HIRATA and Hajime UTSUNOMIYA (hereinafter referred to as ASSIGNORS), having mailing addresses of c/o TDK Corporation, 1-13-1, Nihonbashi, Chuo-ku, Tokyo, 103-8272, Japan, c/o TDK Corporation, 1-13-1, Nihonbashi, Chuo-ku, Tokyo, 103-8272, Japan, c/o TDK Corporation, 1-13-1, Nihonbashi, Chuo-ku, Tokyo, 103-8272, Japan, c/o TDK Corporation, 1-13-1, Nihonbashi, Chuo-ku, Tokyo, 103-8272, Japan, c/o TDK Corporation, 1-13-1, Nihonbashi, Chuo-ku, Tokyo, 103-8272, Japan, and c/o TDK Corporation, 1-13-1, Nihonbashi, Chuo-ku, Tokyo, 103-8272, Japan, and c/o TDK Corporation, 1-13-1, Nihonbashi, Chuo-ku, Tokyo, 103-8272, Japan, and c/o TDK Corporation, 1-13-1, Nihonbashi, Chuo-ku, Tokyo, 103-8272, Japan, and c/o TDK Corporation, 1-13-1, Nihonbashi, Chuo-ku, Tokyo, 103-8272, Japan, and c/o TDK Corporation, 1-13-1, Nihonbashi, Chuo-ku, Tokyo, 103-8272, Japan, and c/o TDK Corporation, 1-13-1, Nihonbashi, Chuo-ku, Tokyo, 103-8272, Japan, and c/o TDK Corporation, 1-13-1, Nihonbashi, Chuo-ku, Tokyo, 103-8272, Japan, and c/o TDK Corporation, 1-13-1, Nihonbashi, Chuo-ku, Tokyo, 103-8272, Japan, and c/o TDK Corporation, 1-13-1, Nihonbashi, Chuo-ku, Tokyo, 103-8272, Japan, and c/o TDK Corporation, 1-13-1, Nihonbashi, Chuo-ku, Tokyo, 103-8272, Japan, respectively, are the joint inventors of an invention entitled

" OPTICAL RECORDING MEDIUM AND METHOD FOR OPTICALLY RECORDING DATA IN THE SAME,"

as described and claimed in the specification forming part of an application for United States letters patent executed herewith. This application claims the benefit of Japanese Patent Application No. 2002-160175, filed on May 31, 2002.

WHEREAS, TDK Corporation (hereinafter referred to as ASSIGNEE), a corporation of the Country of Japan having a place of business at 1-13-1, Nihonbashi, Chuo-ku, Tokyo, 103-8272, Japan, is desirous of acquiring the entire right, title and interest in and to the invention and in and to any letters patent that may be granted therefor in the United States and in any and all foreign countries;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNORS hereby sell, assign and transfer unto said ASSIGNEE, the entire right, title and interest in and to said invention, said application and any and all letters patent which may be granted for said invention in the United States of America and its territorial possessions and in any and all foreign countries, and in any and all divisions, reissues and continuations thereof, including the right to file foreign applications directly in the name of ASSIGNEE and to claim priority rights deriving from said United States application to which said foreign applications are entitled by virtue of international convention, treaty or otherwise, said invention, application and all letters patent on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns for their use and benefit and of their successors and assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNORS had this assignment, transfer and sale not been made. ASSIGNORS hereby authorize and request the Commissioner of Patents and Trademarks to issue all letters patent on said invention to ASSIGNEE. ASSIGNORS agree to execute all instruments and documents required for the making and prosecution of applications for United States and foreign letters

PATENT REEL: 014113 FRAME: 0357

patent on said invention, for litigation regarding said letters patent, or for the purpose of protecting title to said invention or letters patent therefor.

May 20, 2003	Masuki aoshima
Date	Masaki AOSHIMA
Witness	
Date	
May 20, 2003	Hiroyasu INOUE
Date	Hiroyasu INOUE
Witness	
Date	
May 20, 2003	Koji Mishima
Date	Koji MISHIMA
Witness	
Date	

May 20, 2003	Hideki Hircata
Date	Hideki HIRATA
Witness	
Date	
May 20, 2003	Hajime Utsunomiya
Date	Hajime UTSUNOMIYA
Witness	
Date	

(DVC:jks) 890050.401 268857_1.DOC